

Advanced Power MOSFET

SSF9N90A

FEATURES

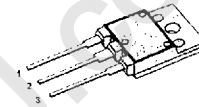
- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- Lower Leakage Current : 25 μ A (Max.) @ $V_{DS} = 900V$
- Low $R_{DS(ON)}$: 0.938 Ω (Typ.)

$$BV_{DSS} = 900 \text{ V}$$

$$R_{DS(on)} = 1.4 \Omega$$

$$I_D = 6 \text{ A}$$

TO-3PF



1. Gate 2. Drain 3. Source

Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
V_{DSS}	Drain-to-Source Voltage	900	V
I_D	Continuous Drain Current ($T_c=25^\circ\text{C}$)	6	A
	Continuous Drain Current ($T_c=100^\circ\text{C}$)	3.8	
I_{DM}	Drain Current-Pulsed ①	36	A
V_{GS}	Gate-to-Source Voltage	± 30	V
E_{AS}	Single Pulsed Avalanche Energy ②	762	mJ
I_{AR}	Avalanche Current ①	6	A
E_{AR}	Repetitive Avalanche Energy ①	10	mJ
dv/dt	Peak Diode Recovery dv/dt ③	1.5	V/ns
P_D	Total Power Dissipation ($T_c=25^\circ\text{C}$)	100	W
	Linear Derating Factor	0.8	
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 to +150	$^\circ\text{C}$
T_L	Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5-seconds	300	

Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	1.25	$^\circ\text{C}$
$R_{\theta JA}$	Junction-to-Ambient	--	40	



Electrical Characteristics ($T_C=25\text{ }^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
BV_{DSS}	Drain-Source Breakdown Voltage	900	--	--	V	$V_{GS}=0V, I_D=250\mu A$
$\Delta BV/\Delta T_J$	Breakdown Voltage Temp. Coeff.	--	1.11	--	V/ $^\circ\text{C}$	$I_D=250\mu A$ See Fig 7
$V_{GS(th)}$	Gate Threshold Voltage	2.0	--	3.5	V	$V_{DS}=5V, I_D=250\mu A$
I_{GSS}	Gate-Source Leakage, Forward	--	--	100	nA	$V_{GS}=30V$
	Gate-Source Leakage, Reverse	--	--	-100	nA	$V_{GS}=-30V$
I_{DSS}	Drain-to-Source Leakage Current	--	--	25	μA	$V_{DS}=900V$
		--	--	250		$V_{DS}=720V, T_C=125\text{ }^\circ\text{C}$
$R_{DS(on)}$	Static Drain-Source On-State Resistance	--	--	1.4	Ω	$V_{GS}=10V, I_D=3A$ ④*
g_{fs}	Forward Transconductance	--	5.5	--	S	$V_{DS}=50V, I_D=3A$ ④
C_{iss}	Input Capacitance	--	2760	3580	pF	$V_{GS}=0V, V_{DS}=25V, f=1\text{MHz}$ See Fig 5
C_{oss}	Output Capacitance	--	245	290		
C_{rss}	Reverse Transfer Capacitance	--	105	125		
$t_{d(on)}$	Turn-On Delay Time	--	29	70	ns	$V_{DD}=450V, I_D=10A,$ $R_G=9.6\ \Omega$ See Fig 13 ④ ⑤
t_r	Rise Time	--	54	120		
$t_{d(off)}$	Turn-Off Delay Time	--	161	330		
t_f	Fall Time	--	47	105		
Q_g	Total Gate Charge	--	127	165	nC	$V_{DS}=720V, V_{GS}=10V,$ $I_D=10A$ See Fig 6 & Fig 12 ④ ⑤
Q_{gs}	Gate-Source Charge	--	19.2	--		
Q_{gd}	Gate-Drain("Miller") Charge	--	56.8	--		

Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
I_S	Continuous Source Current	--	--	6	A	Integral reverse pn-diode in the MOSFET
I_{SM}	Pulsed-Source Current ①	--	--	36		
V_{SD}	Diode Forward Voltage ④	--	--	1.4	V	$T_J=25\text{ }^\circ\text{C}, I_S=6A, V_{GS}=0V$
t_{rr}	Reverse Recovery Time	--	690	--	ns	$T_J=25\text{ }^\circ\text{C}, I_F=10A$
Q_{rr}	Reverse Recovery Charge	--	11.94	--	μC	$di_F/dt=100A/\mu\text{s}$ ④

Notes ;

- Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- $L=40\text{mH}, I_{AS}=6A, V_{DD}=50V, R_G=27\Omega,$ Starting $T_J=25\text{ }^\circ\text{C}$
- $I_{SD} \leq 10A, di/dt \leq 190A/\mu\text{s}, V_{DD} \leq BV_{DSS},$ Starting $T_J=25\text{ }^\circ\text{C}$
- Pulse Test : Pulse Width = $250\mu\text{s},$ Duty Cycle $\leq 2\%$
- Essentially Independent of Operating Temperature

Fig 1. Output Characteristics

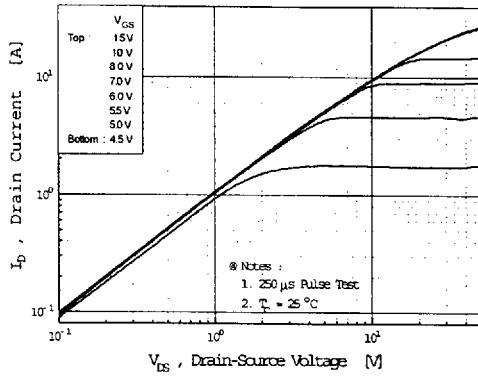


Fig 2. Transfer Characteristics

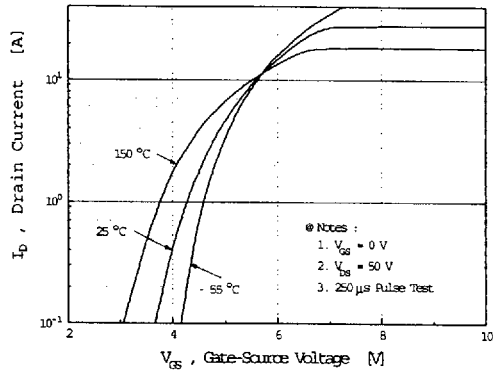


Fig 3. On-Resistance vs. Drain Current

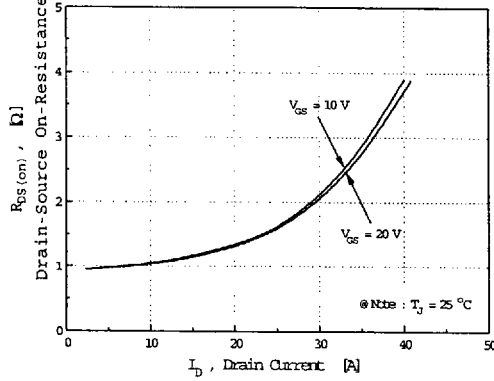


Fig 4. Source-Drain Diode Forward Voltage

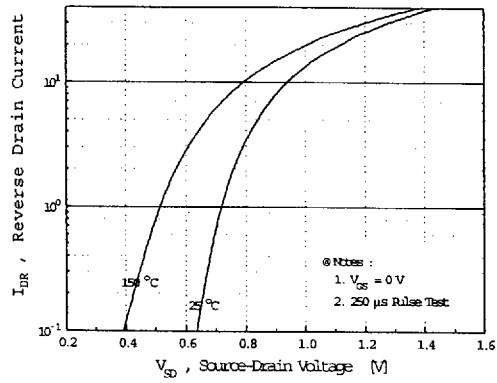


Fig 5. Capacitance vs. Drain-Source Voltage

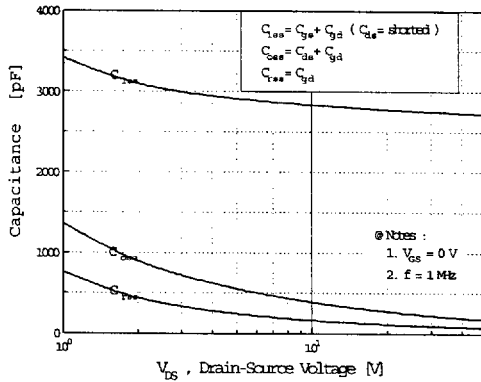
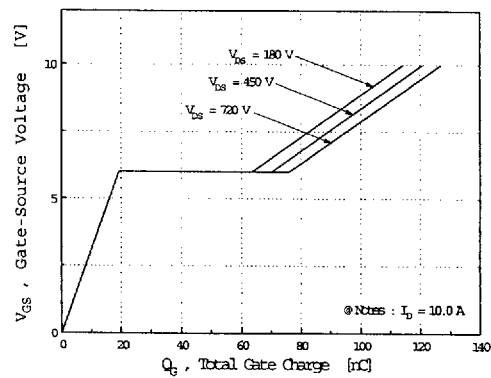


Fig 6. Gate Charge vs. Gate-Source Voltage



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N-CHANNEL POWER MOSFET

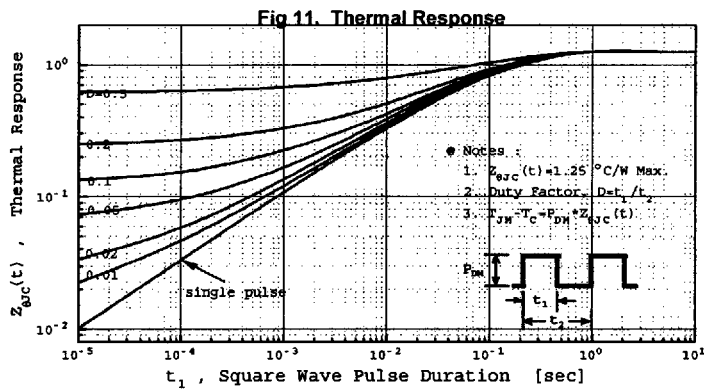
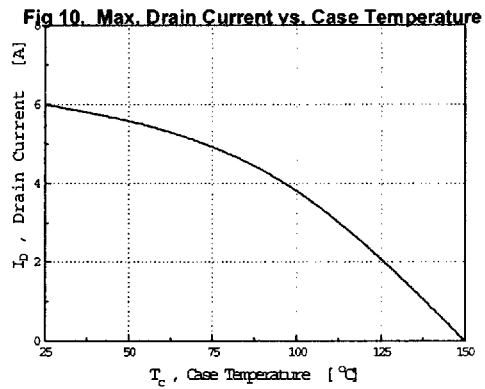
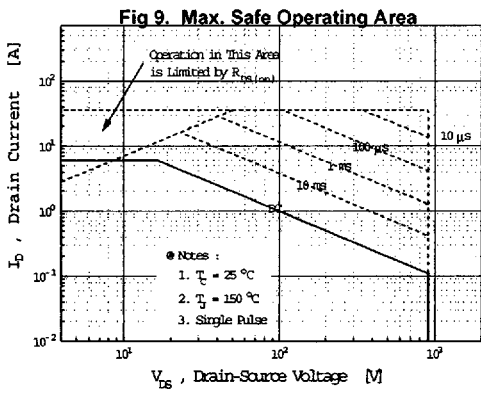
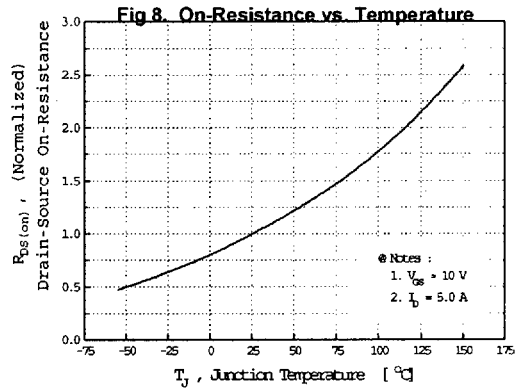
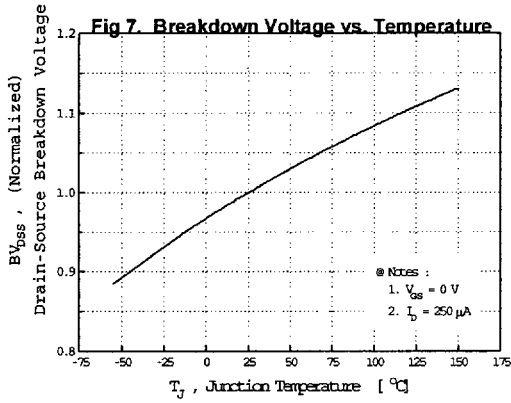


Fig 12. Gate Charge Test Circuit & Waveform

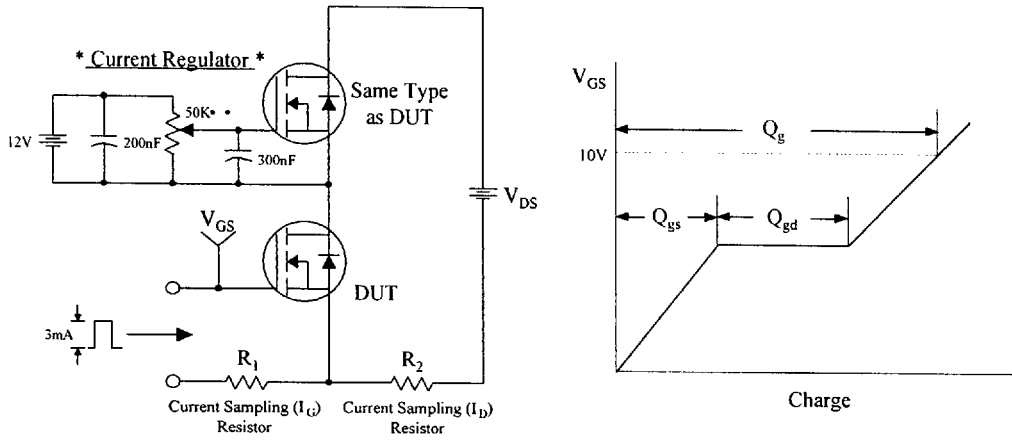


Fig 13. Resistive Switching Test Circuit & Waveforms

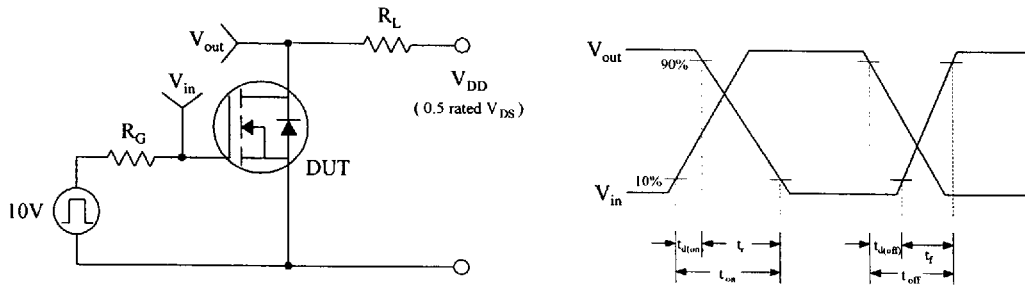


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

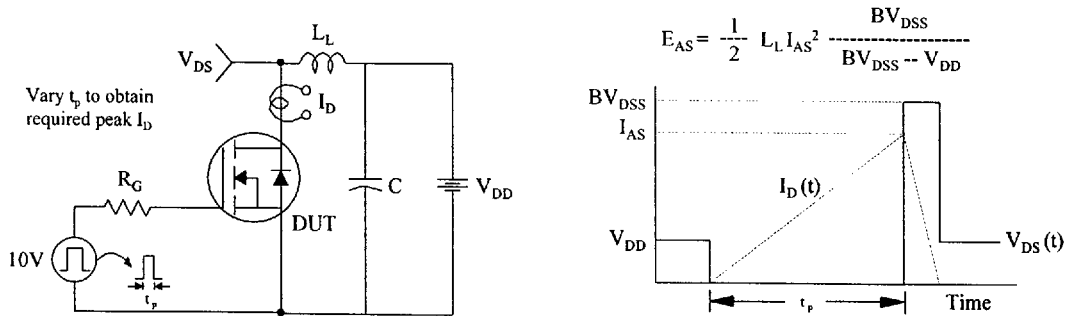
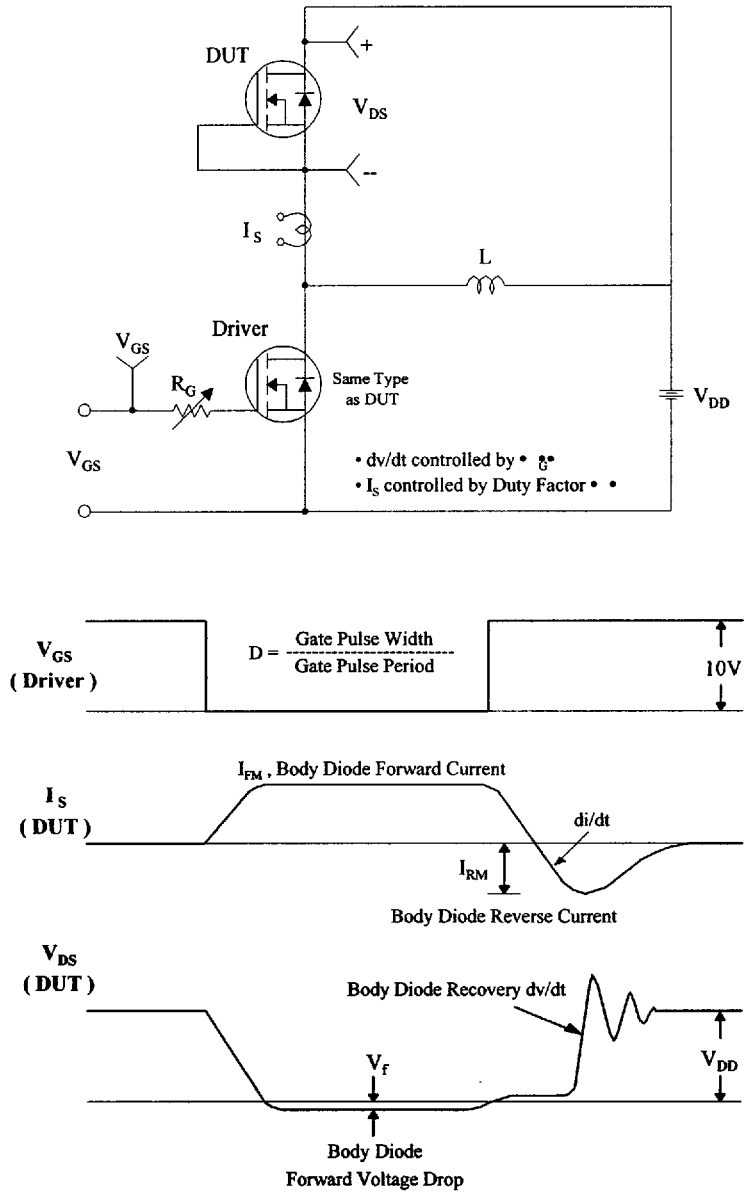
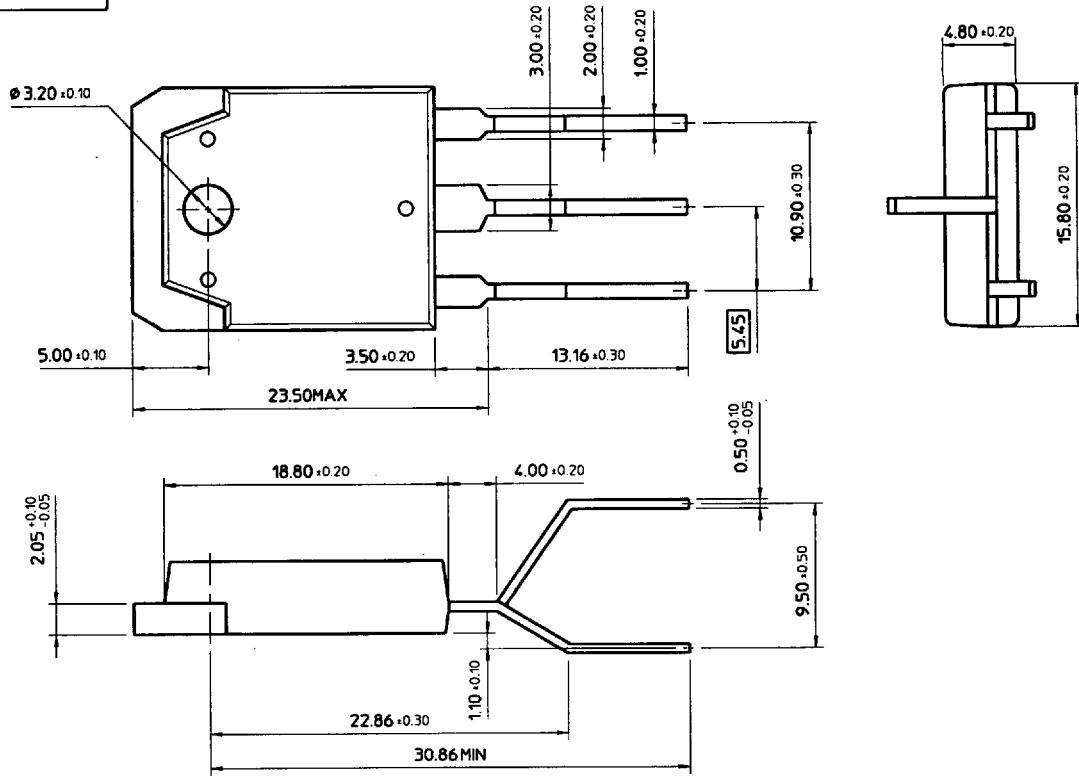


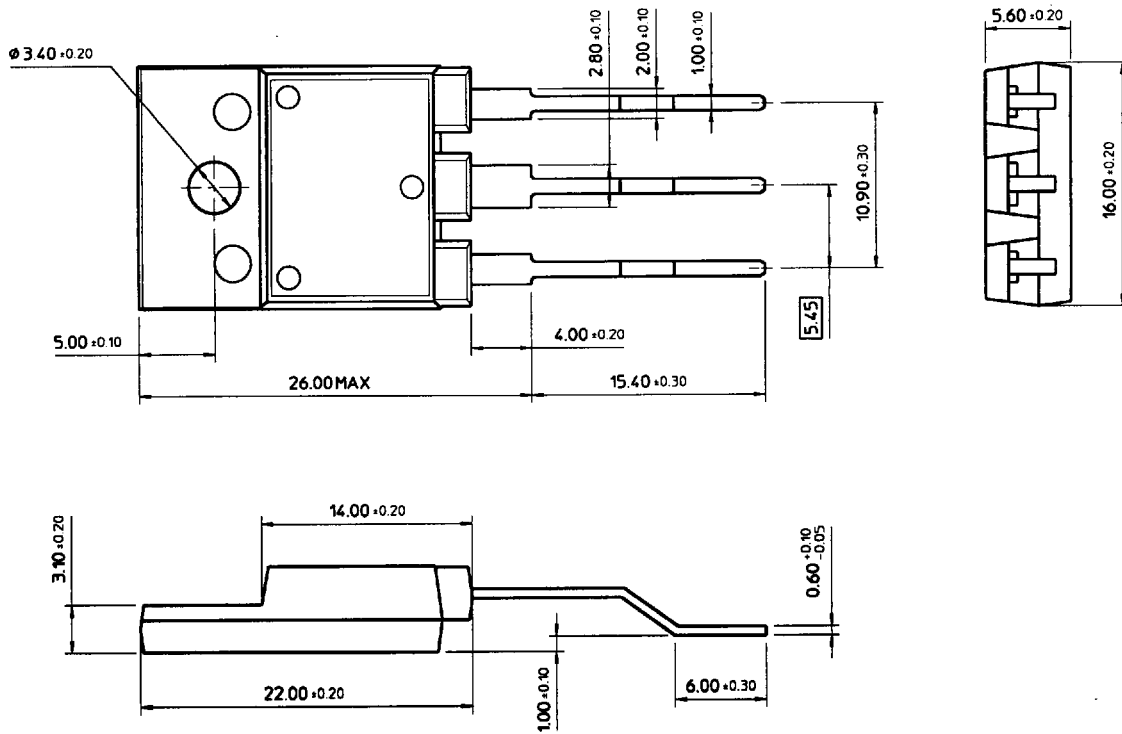
Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



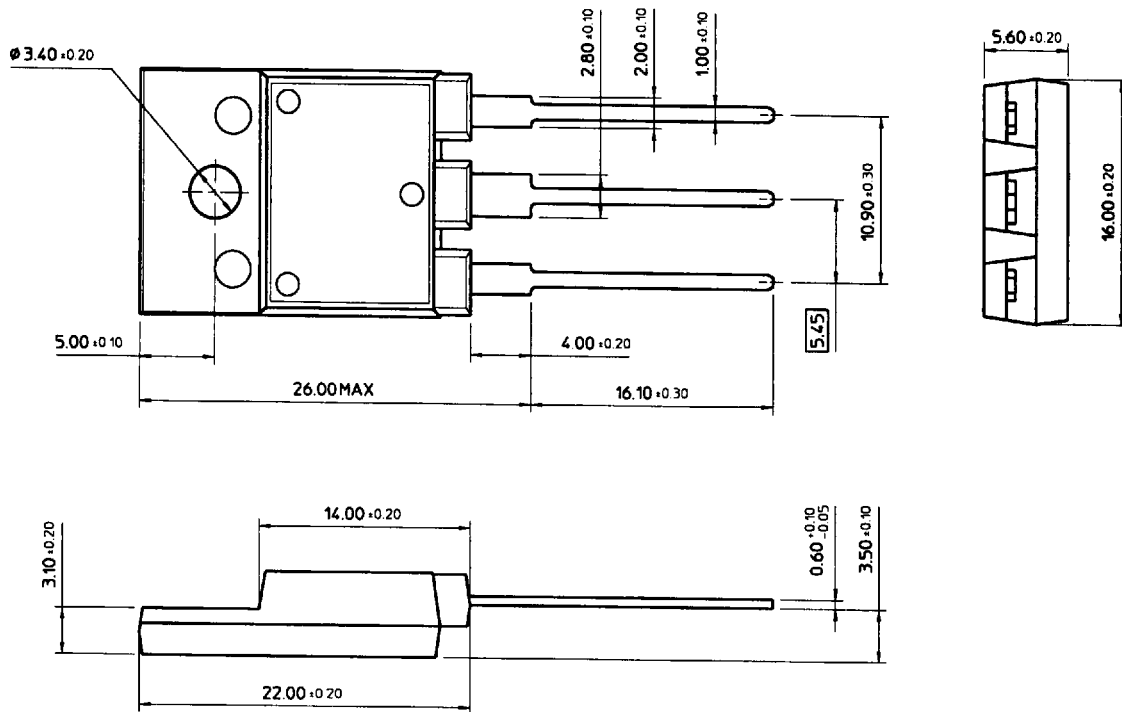
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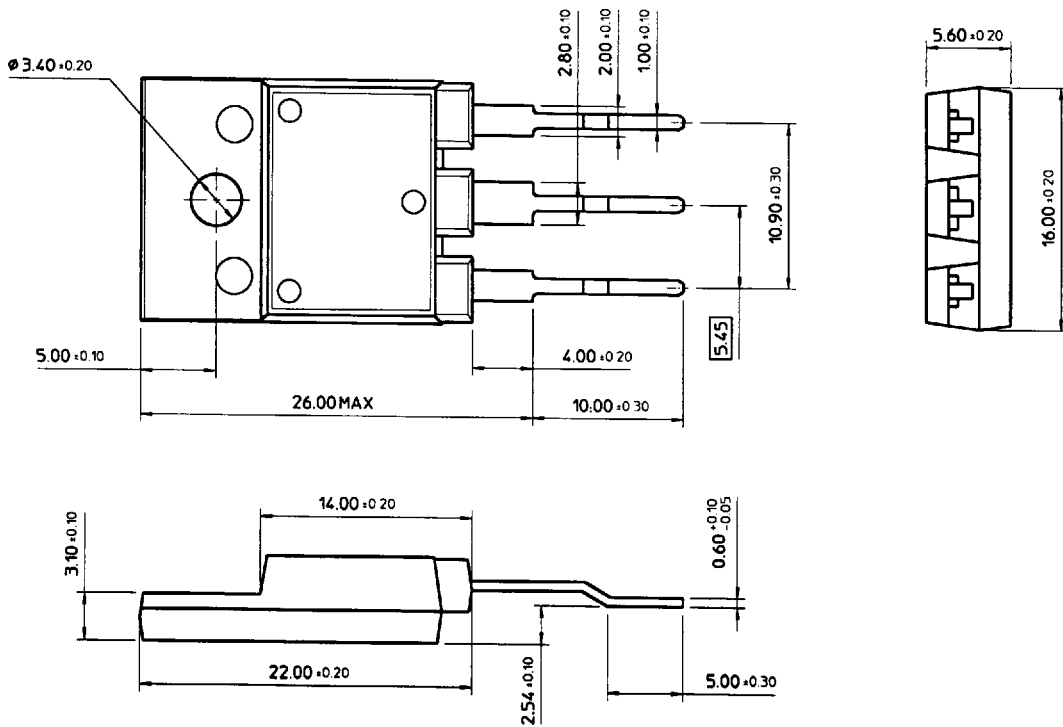
T0-3PF (1)



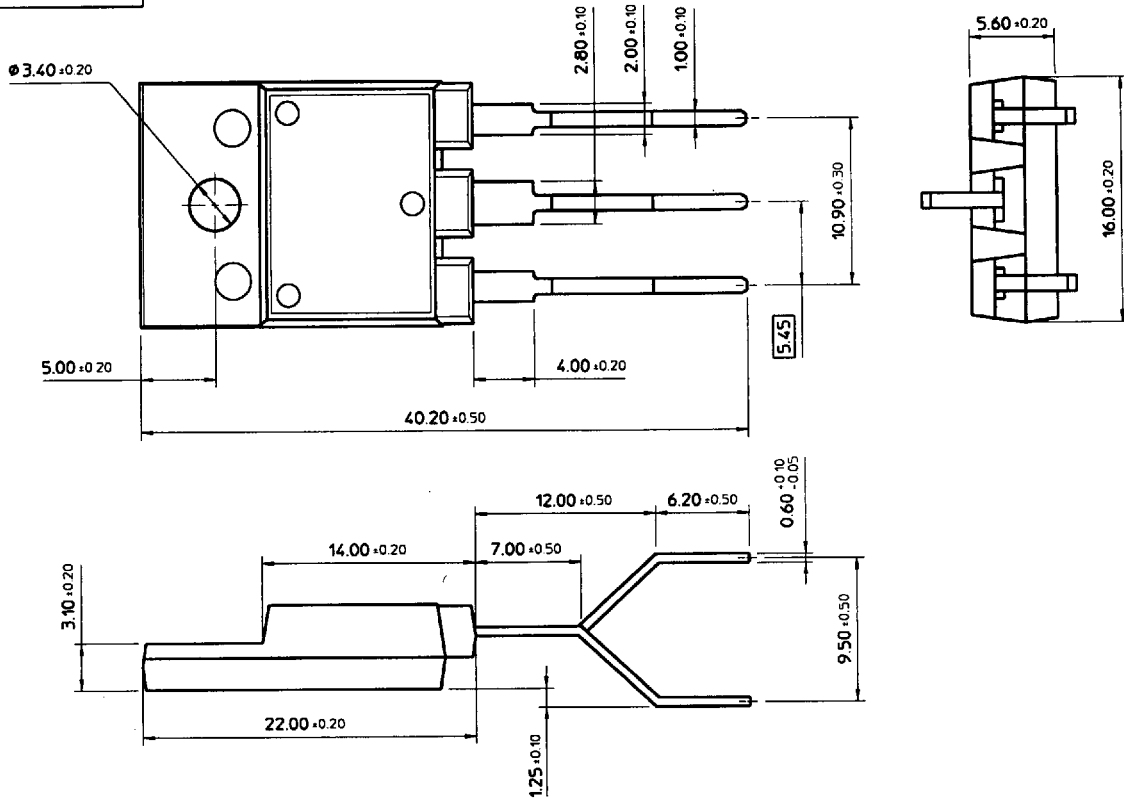
TO-3PF (2)



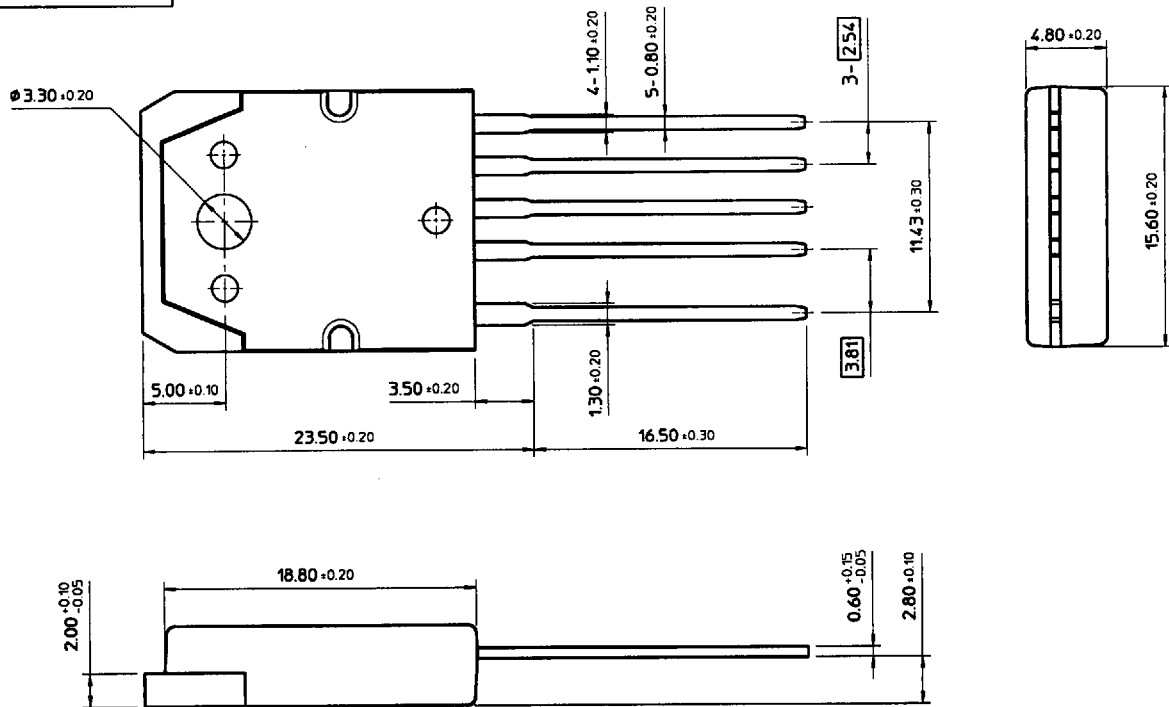
TO-3PF (3)



TO-3PF (4)



TO-3P-5L



Under Development